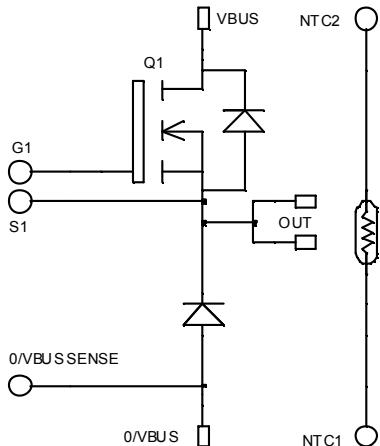


**Buck chopper
MOSFET Power Module**

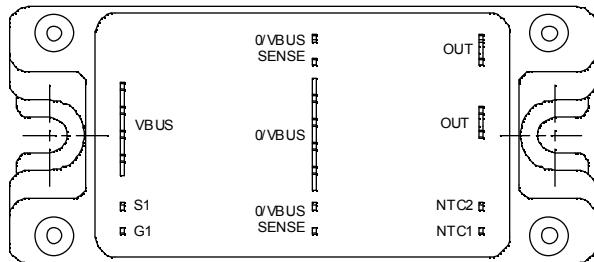
V_{DSS} = 1000V
R_{DSon} = 180mΩ typ @ T_j = 25°C
I_D = 43A @ T_c = 25°C


Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Power MOS 7® MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration


Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{DSS}	Drain - Source Breakdown Voltage	1000	V
I _D	Continuous Drain Current	T _c = 25°C 43	A
		T _c = 80°C 33	
I _{DM}	Pulsed Drain current	172	
V _{GS}	Gate - Source Voltage	±30	V
R _{DSon}	Drain - Source ON Resistance	210	mΩ
P _D	Maximum Power Dissipation	T _c = 25°C 780	W
I _{AR}	Avalanche current (repetitive and non repetitive)	25	A
E _{AR}	Repetitive Avalanche Energy	50	mJ
E _{AS}	Single Pulse Avalanche Energy	3000	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 1000\text{V}$	$T_j = 25^\circ\text{C}$			200	μA
		$V_{GS} = 0\text{V}$, $V_{DS} = 800\text{V}$	$T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$, $I_D = 21.5\text{A}$			180	210	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 5\text{mA}$		3		5	V
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{ V}$, $V_{DS} = 0\text{V}$				± 150	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			10.4		nF
C_{oss}	Output Capacitance				1.76		
C_{rss}	Reverse Transfer Capacitance				0.32		
Q_g	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 500\text{V}$ $I_D = 43\text{A}$			372		nC
Q_{gs}	Gate – Source Charge				48		
Q_{gd}	Gate – Drain Charge				244		
$T_{d(on)}$	Turn-on Delay Time	Inductive switching @ 125°C $V_{GS} = 15\text{V}$ $V_{Bus} = 670\text{V}$ $I_D = 43\text{A}$			18		ns
T_r	Rise Time				12		
$T_{d(off)}$	Turn-off Delay Time				155		
T_f	Fall Time		$R_G = 2.5\Omega$		40		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C $V_{GS} = 15\text{V}$, $V_{Bus} = 670\text{V}$ $I_D = 43\text{A}$, $R_G = 2.5\Omega$			1800		μJ
E_{off}	Turn-off Switching Energy				1246		
E_{on}	Turn-on Switching Energy		Inductive switching @ 125°C $V_{GS} = 15\text{V}$, $V_{Bus} = 670\text{V}$ $I_D = 43\text{A}$, $R_G = 2.5\Omega$		2846		μJ
E_{off}	Turn-off Switching Energy				1558		

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit	
V_{RRM}	Maximum Peak Repetitive Reverse Voltage	$V_R = 1000\text{V}$	$T_j = 25^\circ\text{C}$			1000	V	
I_{RM}	Maximum Reverse Leakage Current		$T_j = 125^\circ\text{C}$			250		
I_F	DC Forward Current		$T_c = 100^\circ\text{C}$		60		A	
V_F	Diode Forward Voltage	$I_F = 60\text{A}$			1.9	2.5	V	
		$I_F = 120\text{A}$			2.2			
		$I_F = 60\text{A}$	$T_j = 125^\circ\text{C}$		1.7			
t_{rr}	Reverse Recovery Time	$I_F = 60\text{A}$ $V_R = 670\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		280		ns	
			$T_j = 125^\circ\text{C}$		350			
Q_{rr}	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		760		nC	
			$T_j = 125^\circ\text{C}$		3600			



Thermal and package characteristics

Symbol	Characteristic		Min	Typ	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance	Transistor			0.16	°C/W
		Diode			0.9	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$, 50/60Hz		2500			V
T_J	Operating junction temperature range		-40		150	
T_{STG}	Storage Temperature Range		-40		125	°C
T_C	Operating Case Temperature		-40		100	
Torque	Mounting torque	To Heatsink	M5	2.5	4.7	N.m
Wt	Package Weight				160	g

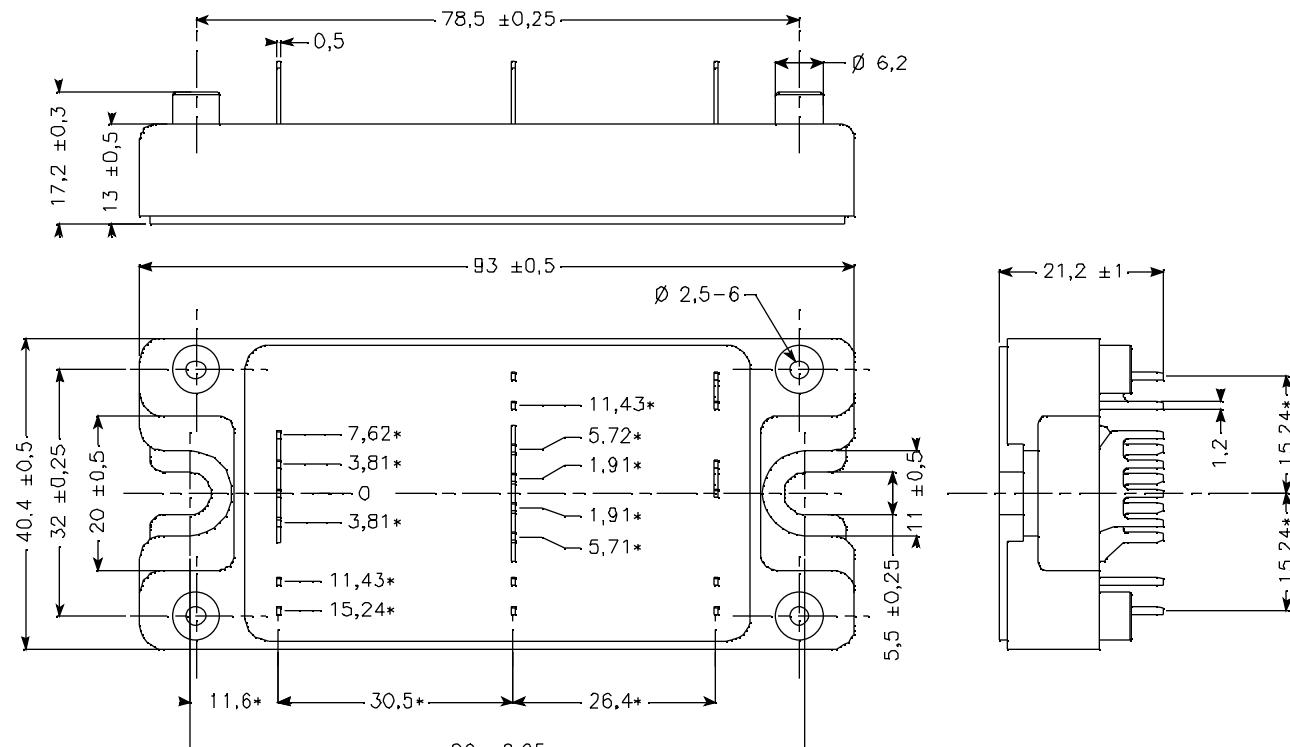
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic		Min	Typ	Max	Unit
R_{25}	Resistance @ 25°C			50		kΩ
$B_{25/85}$	$T_{25} = 298.15\text{ K}$			3952		K

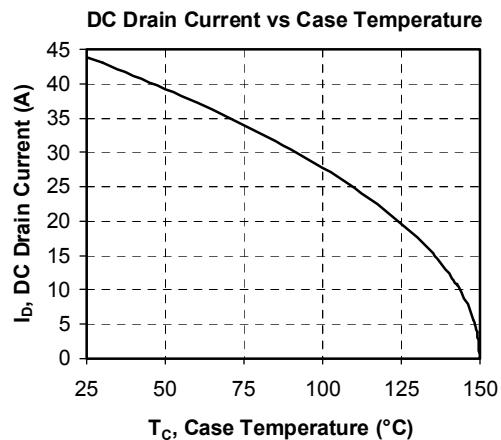
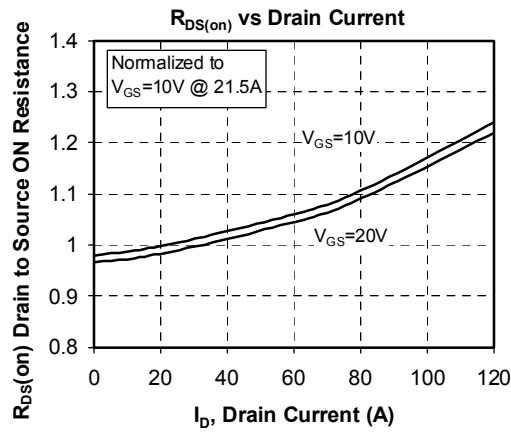
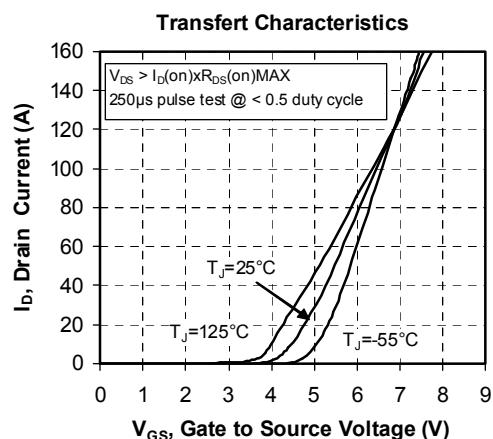
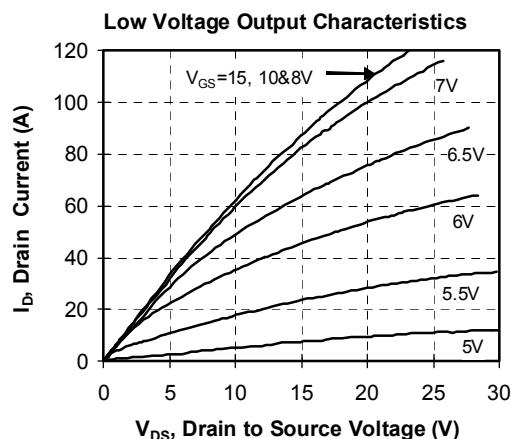
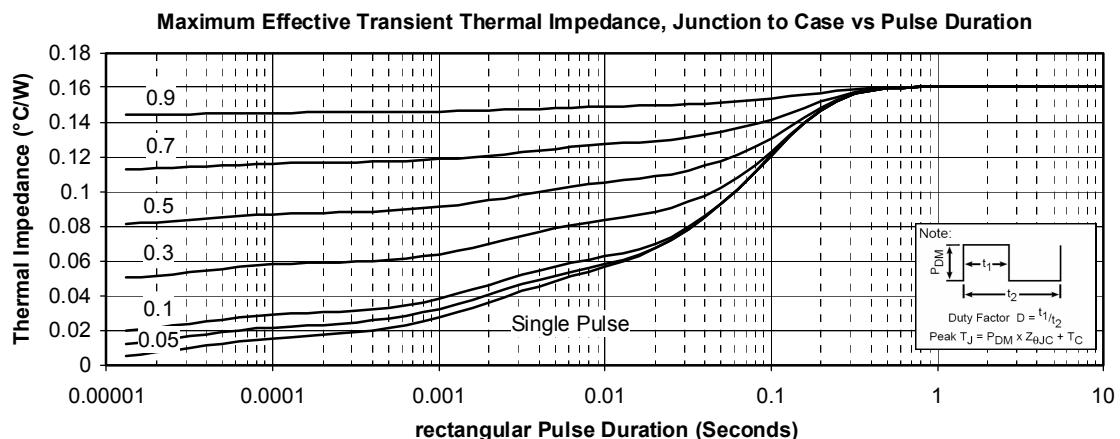
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad T: \text{Thermistor temperature}$$

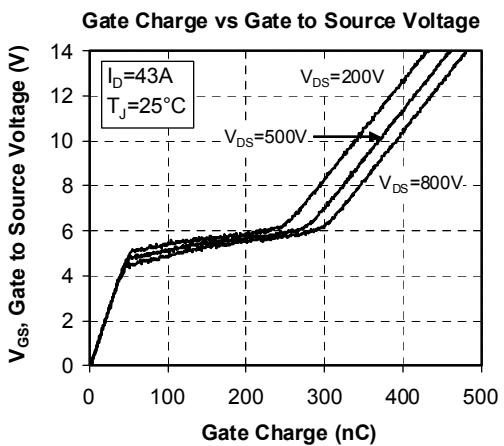
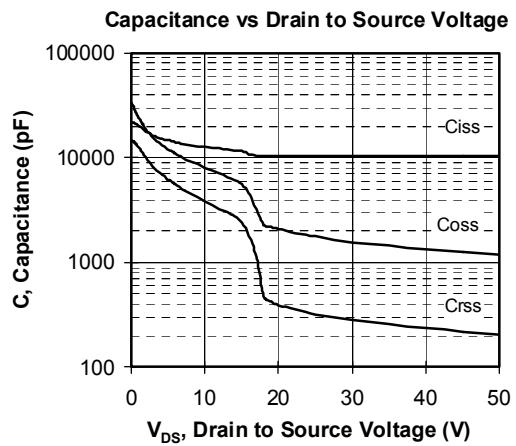
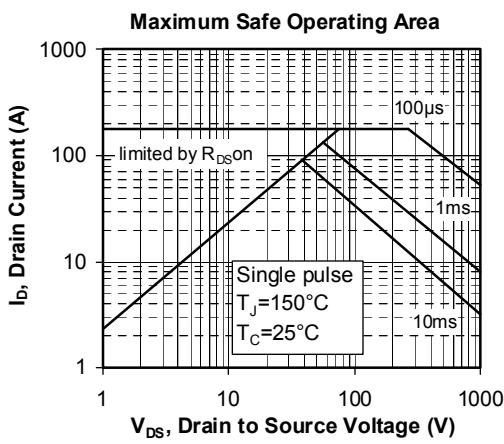
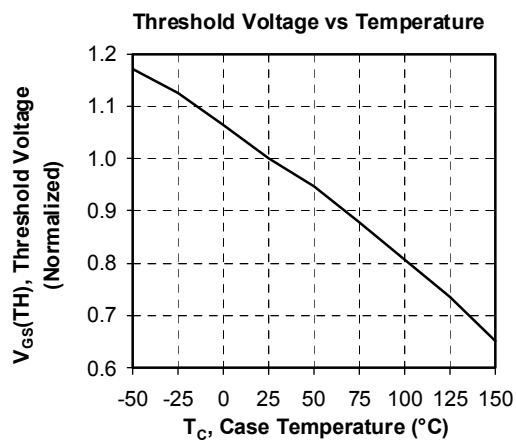
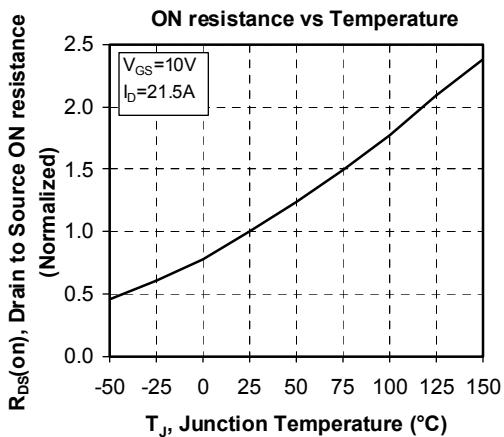
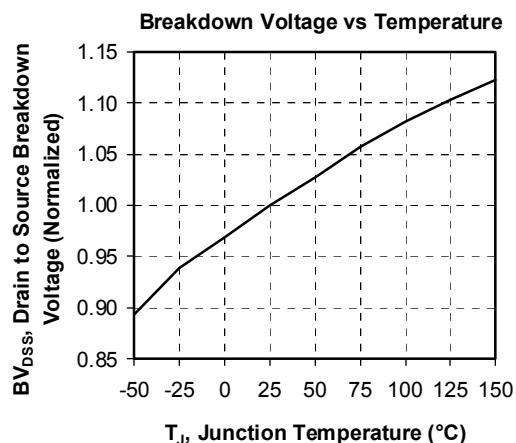
R_T : Thermistor value at T

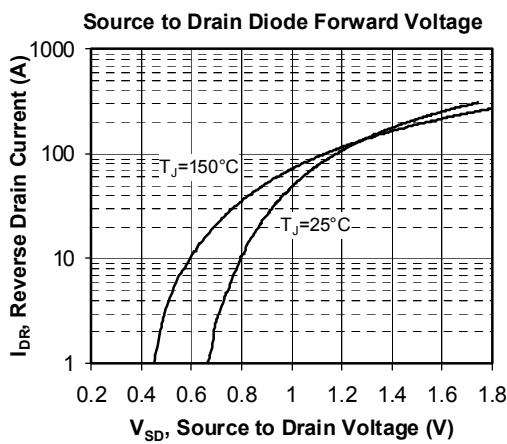
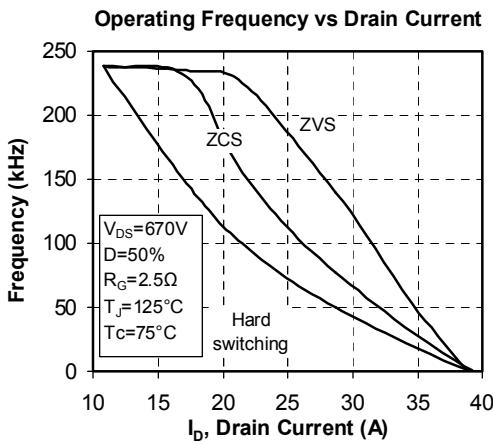
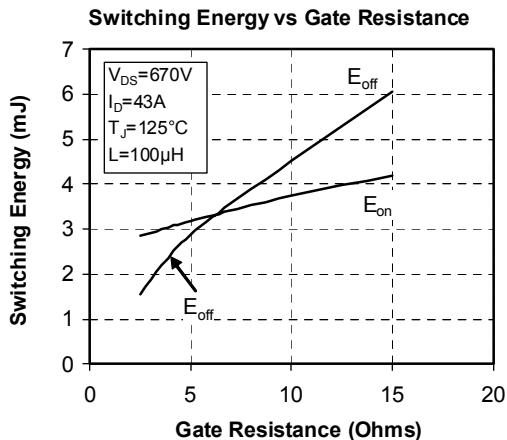
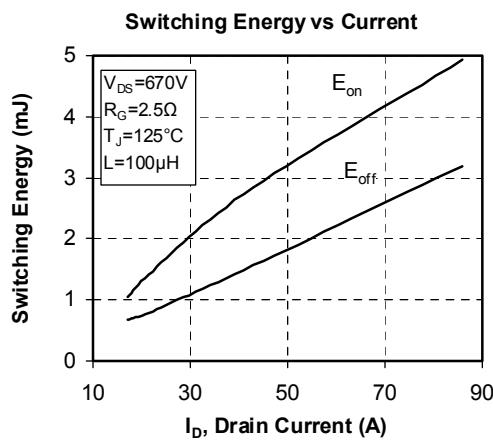
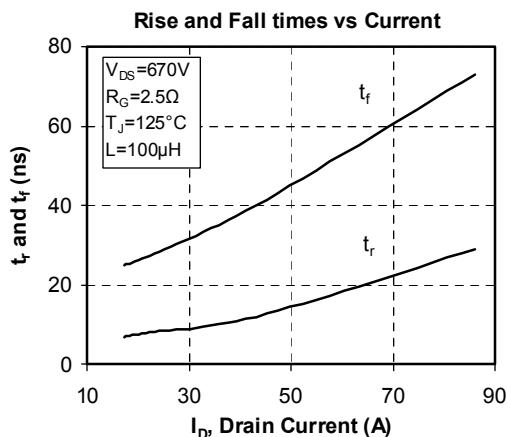
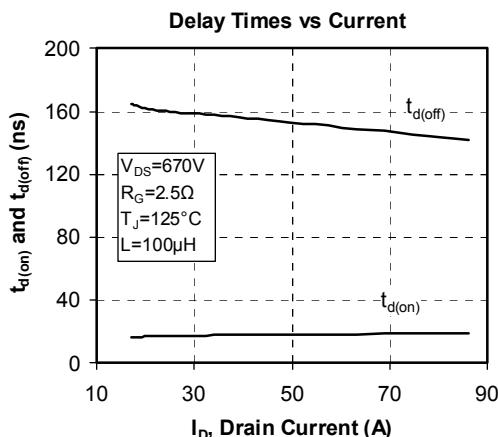
SP4 Package outline (dimensions in mm)



See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

Typical Performance Curve






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